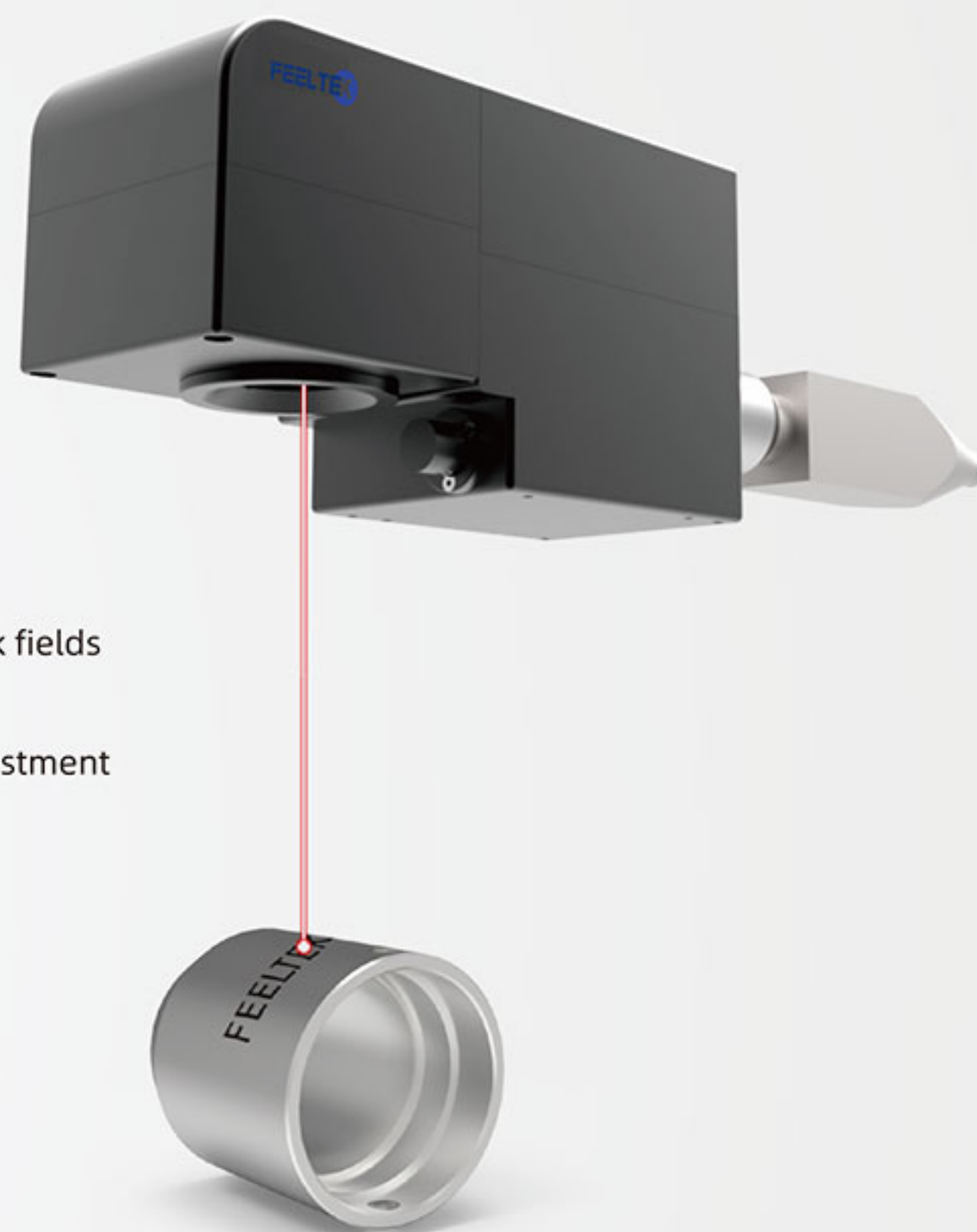


# 3D Dynamic Focus System

## Entry priority for the industry

- Compact design, easy for integration.
- Focal length data preservation when switching work field.
- The adjustment knob is used to switch between different work fields without replacing any parts.
- The optical adjuster could solve the common difficulty of adjustment from QCS interface optical offset. Once adjusted, accurate to the central point.



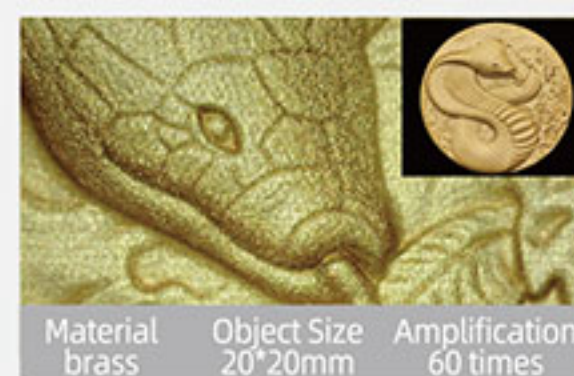
### 3D Surface Processing

The FR10-F applies dynamic focus control technology, breaks the limitation of traditional marking, and can do no distortion marking in the large-scale surface, 3D surface, steps, cone surface, slope surface and other objects.

	Regular Scanhead	FR10-F
Cylinder surface	<p>Can not cover focal points at two edges, distorted edge marking effect</p>	
Different steps	<p>Can not cover focal points on two different heights, no average marking</p>	
Cone surface	<p>Can not cover focal points on the cone, distorted marking effect</p>	
Slope surface	<p>Can not cover focal points on the slope, distorted marking effect</p>	

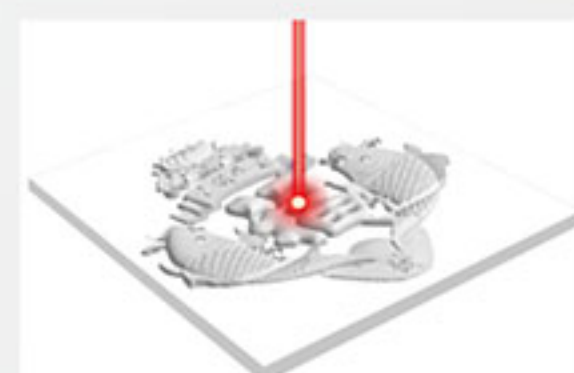
### Engraving

The dynamic axis collaborates with the XY axis scanhead, can easily achieve layered relief, deep carving and texture etching.



### High Precision

With the increasing processing layer, the dynamic focus axis jointly adjusts the focal length and spot in real-time to ensure that the focus spot controllable during the whole processing process, which can achieve higher accuracy compared with traditional scanhead.



### High Efficiency

The dynamic axis is fully coordinated with the XY axis, and the hierarchical focus compensation is completed with in microseconds with a more efficient job.

### Application Highlight



- 3D marking
- Engraving
- Cleaning
- Precision mould
- Surface treatment
- Texture etching
- PCB Marking



3D marking



3D surface tracking code marking



3D surface engraving



Male&amp;Female mould engraving



Special material deep engraving (material: SiC)

### Product Technical Information

Technical Info.		Specifications	
Items	Output Voltage(VDC)	±15	
	Current(A)	10A	
	Protocol	XY2-100 Protocol	
	Weight (KG)	7	
	Size(mm)	292*115*152.8	
Optical Specifications	Aperture Size(mm)	10	
	Input beam diameter(mm)	8.5	
Galvanometer Specifications	Product line	Standard / Pro	
	Scan Angle(°)	±10	
	Repeatability(μrad)	8	
	Max.Gain Drift(ppm/k)	100	
	Max.Offset Drift(μrad/k)	30	
	Long-term drift over 8h(mrad)	≤0.2	
	Tracking Error(ms)	≤0.13	
	Max.processing speed(characters/s)	600@100×100	
Working Field & Spot Diameter	Working Field(mm)	100×100×15	200×200×80
	The Min.Spot Diameter@1/e²(mm)	0.025	0.0415
	Focal length(mm)	114	234

